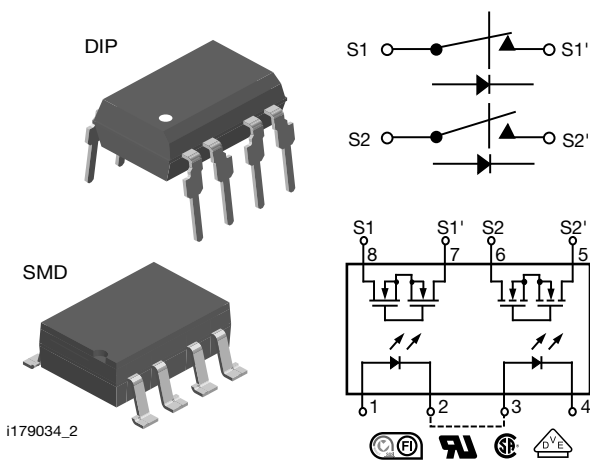


Dual 1 Form A/B, C Solid-State Relay



FEATURES

- Current limit protection
- Isolation test voltage 3750 V_{RMS}
- Typical R_{ON} 10 Ω
- Load voltage 200 V
- Load current 200 mA
- High surge capability
- Clean bounce free switching
- Low power consumption
- SMD lead available on tape and reel
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

APPLICATIONS

- General telecom switching
 - On / off hook control
 - Ring delay
 - Dial pulse
 - Ground start
 - Ground fault protection
- Instrumentation
- Industrial controls

AGENCY APPROVAL

- [UL](#)
- [VDE](#)
- [CQC](#)

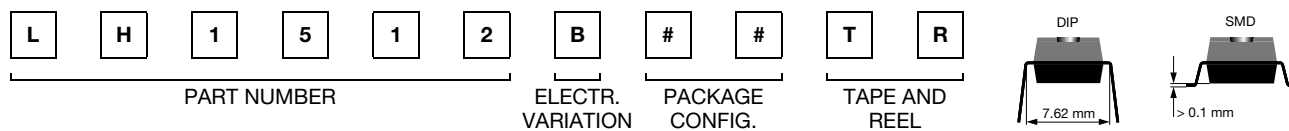
ADDITIONAL RESOURCES



DESCRIPTION

The LH1512 relays contain normally open and normally closed switches that can be used independently as a 1 form A and 1 form B relay, or when used together, as a 1 form C relay. The relays are constructed as a mult.-chip hybrid device. Actuation control is via an infrared LED. The output switch is a combination of a photodiode array with MOSFET switches and control circuitry.

ORDERING INFORMATION



PACKAGE	UL, CSA, FIMKO
SMD-8, tubes	LH1512BAC
SMD-8, tape and reel	LH1512BACTR
DIP-8, tubes	LH1512BB



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
LED continuous forward current		I_F	50	mA
LED reverse voltage	$I_R \leq 10\text{ }\mu\text{A}$	V_R	5	V
OUTPUT				
DC or peak AC load voltage	$I_L \leq 50\text{ }\mu\text{A}$	V_L	200	V
Continuous DC load current (form C operation)		I_L	200	mA
Peak load current, form A	$t = 100\text{ ms}$	I_P	(2)	
Peak load current (single shot), form B		I_P	400	mA
SSR				
Ambient operating temperature range		T_{amb}	-40 to +85	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-40 to +125	$^{\circ}\text{C}$
Pin soldering temperature (3)	$t = 10\text{ s max.}$	T_{sld}	260	$^{\circ}\text{C}$
Input to output isolation test voltage	$t = 1\text{ s, } I_{ISO} = 10\text{ }\mu\text{A max.}$	V_{ISO}	3750	V_{RMS}
Pole-to-pole isolation voltage (S1 to S2) (1) (dry air, dust free, at sea level)			1600	V
Output power dissipation (continuous)		P_{diss}	600	mW

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability
- (1) Breakdown occurs between the output pins external to the package
- (2) Refer to current limit performance application note for a discussion on relay operation during transient currents
- (3) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP)

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
INPUT							
LED forward current switch turn-on (NO)	$I_L = 100\text{ mA, } t = 10\text{ ms}$	I_{Fon}	-	0.6	2	mA	
LED forward current switch turn-off (NO)	$V_L = \pm 150\text{ V}$	I_{Foff}	0.2	0.5	-	mA	
LED forward current switch turn-on (NC)	$I_L = 100\text{ mA, } t = 10\text{ ms}$	I_{Fon}	0.2	0.9	-	mA	
LED forward current switch turn-off (NC)	$V_L = \pm 150\text{ V}$	I_{Foff}	-	1	2	mA	
LED forward voltage	$I_F = 10\text{ mA}$	V_F	1.15	1.26	1.45	V	
OUTPUT							
On-resistance: (NO, NC)	$I_F = 5\text{ mA (NO), } I_F = 0\text{ (NC), } I_L = 50\text{ mA (NC)}$	R_{ON}	-	10	15	Ω	
Off-resistance: (NO)	$I_F = 0\text{ mA, } V_L = \pm 100\text{ V}$	R_{OFF}	0.35	5000	-	$G\Omega$	
Off-resistance: (NC)	$I_F = 5\text{ mA, } V_L = \pm 100\text{ V}$	R_{OFF}	0.1	1.4	-	$G\Omega$	
Current limit: (NO)	$I_F = 5\text{ mA, } t = 5\text{ ms, } V_L = \pm 5\text{ V}$	I_{LMT}	270	360	460	mA	
Off-state leakage current: (NO)	$I_F = 0\text{ mA, } V_L = \pm 100\text{ V}$	I_O	-	0.02	1000	nA	
Off-state leakage current: (NC)	$I_F = 5\text{ mA, } V_L = \pm 100\text{ V}$	I_O	-	0.07	1	μA	
Off-state leakage current: (NO, NC)	$I_F = 0\text{ mA (NO), } I_F = 5\text{ mA, } V_L = \pm 200\text{ V}$	I_O	-		1	μA	
Output capacitance: (NO)	$I_F = 0\text{ mA, } V_L = 50\text{ V}$	C_O	-	60	-	pF	
Output capacitance: (NC)	$I_F = 5\text{ mA, } V_L = 50\text{ V}$	C_O	-	60	-	pF	
TRANSFER							
Capacitance (input to output)	$V_{ISO} = 1\text{ V}$	C_{IO}	-	3	-	pF	

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Turn-on time (NO)	$I_F = 10\text{ mA, } I_L = 50\text{ mA}$	t_{on}	-	1.4	3	ms	
Turn-on time (NC)	$I_F = 10\text{ mA, } I_L = 50\text{ mA}$	t_{on}	-	1.2	3	ms	
Turn-off time (NO)	$I_F = 10\text{ mA, } I_L = 50\text{ mA}$	t_{off}	-	0.7	3	ms	
Turn-off time (NC)	$I_F = 10\text{ mA, } I_L = 50\text{ mA}$	t_{off}	-	2	3	ms	



TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

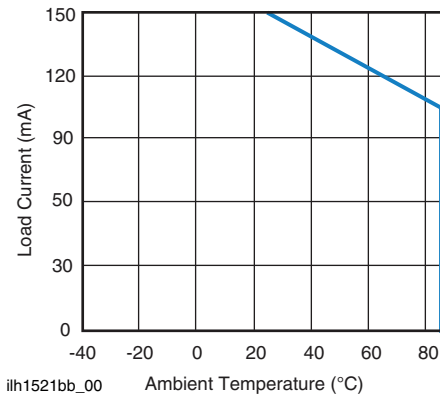


Fig. 1 - Recommended Operating Conditions

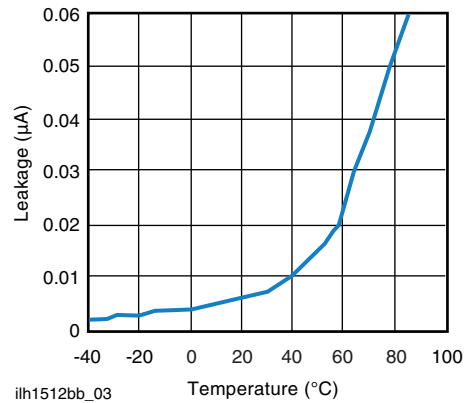


Fig. 4 - Typical Leakage vs. Temperature (Measured across Pin 5 and 6 or 7 and 8)

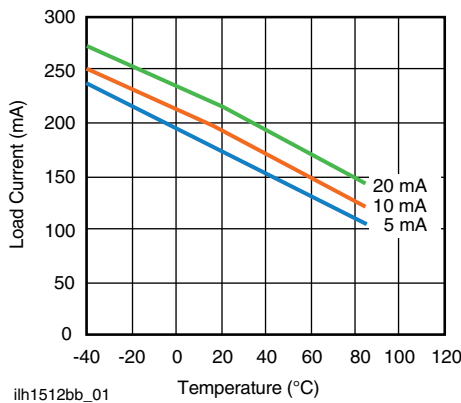


Fig. 2 - Form A Typical Load Current vs. Temperature

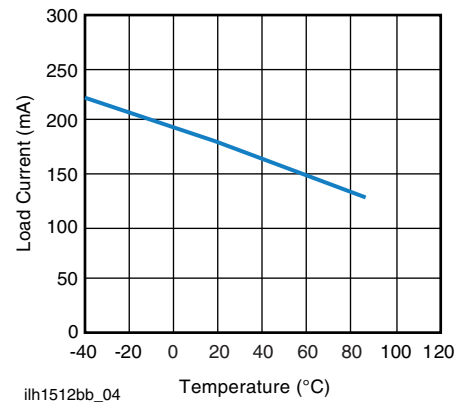


Fig. 5 - Form B Typical Load Current vs. Temperature

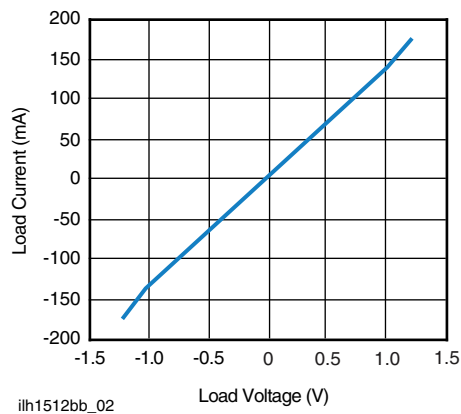


Fig. 3 - Form A Typical Load Current vs. Load Voltage

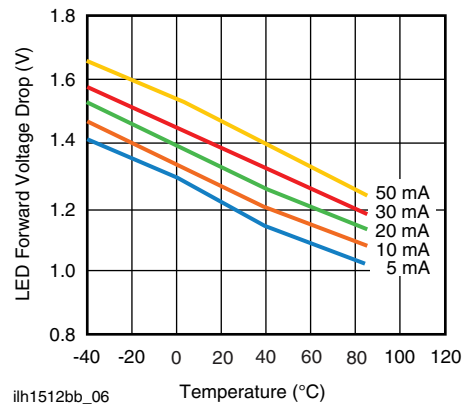


Fig. 6 - Typical LED Forward Voltage Drop vs. Temperature

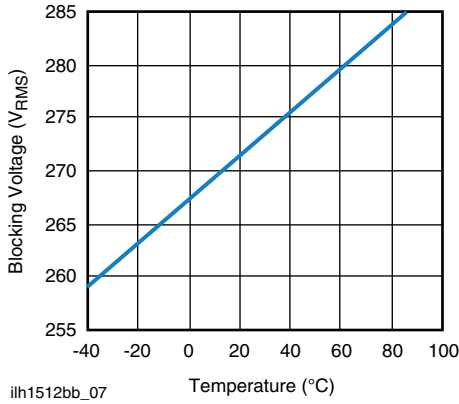


Fig. 7 - Form A Typical Blocking Voltage vs. Temperature

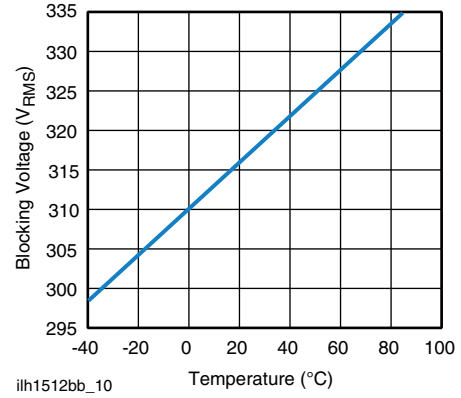


Fig. 10 - Form B Typical Blocking Voltage vs. Temperature

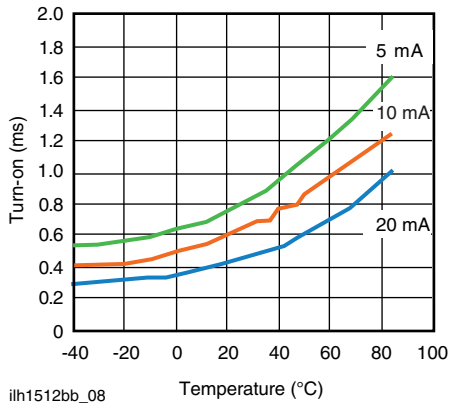


Fig. 8 - Form A Typical Turn-On vs. Temperature

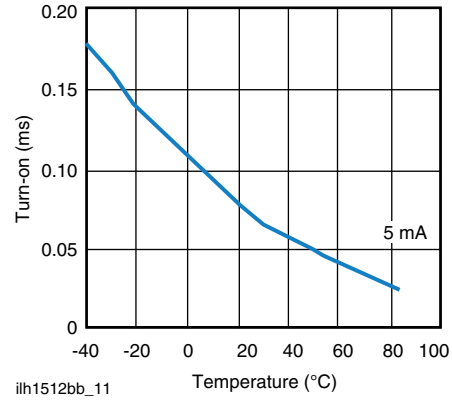


Fig. 11 - Form B Typical Turn-On vs. Temperature

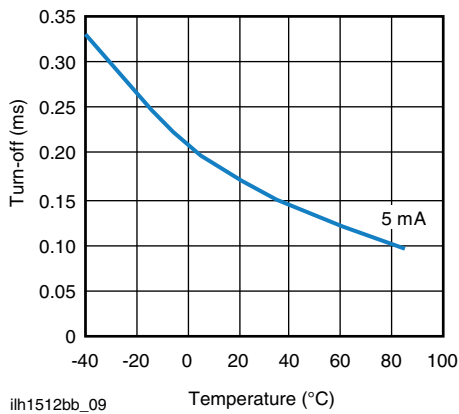


Fig. 9 - Form A Typical Turn-Off vs. Temperature

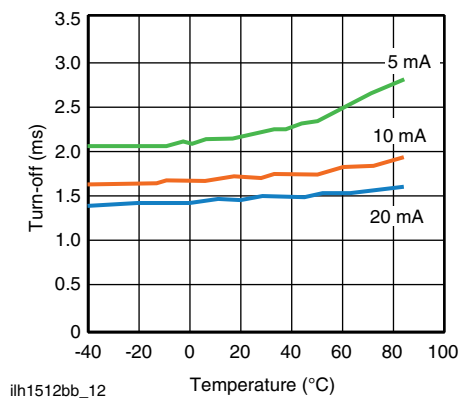


Fig. 12 - Form B Typical Turn-Off vs. Temperature

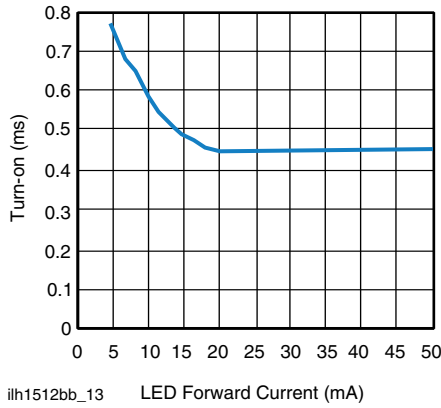


Fig. 13 - Form A Typical Turn-On vs. LED Forward Current

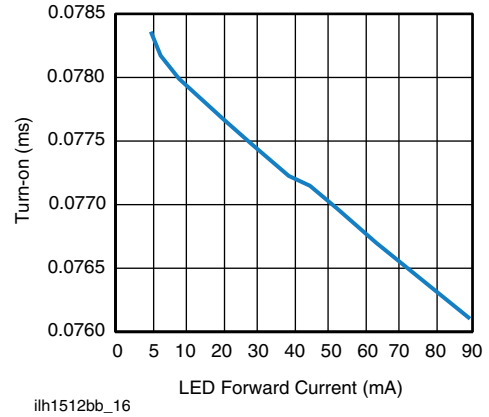


Fig. 16 - Form B Typical Turn-On vs. LED Forward Current

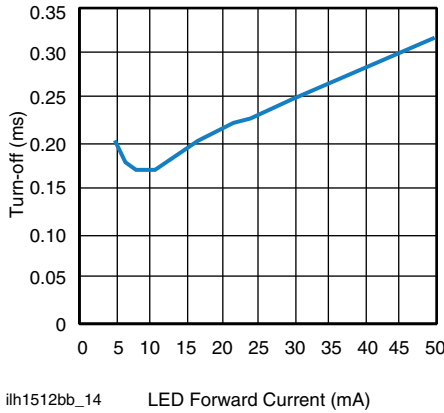


Fig. 14 - Form A Typical Turn-Off vs. LED Forward Current

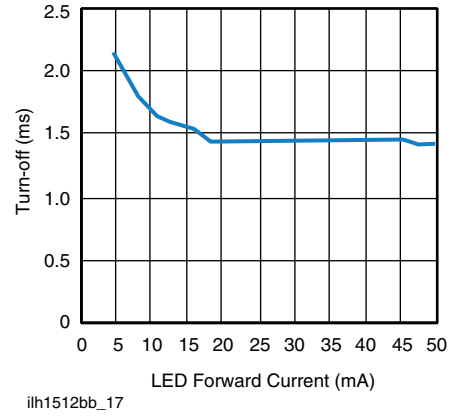


Fig. 17 - Form B Typical Turn-Off vs. LED Forward Current

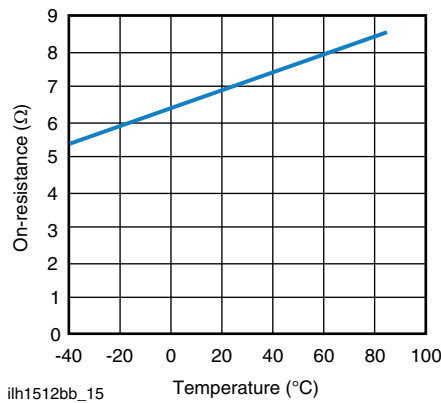


Fig. 15 - Form A Typical On-Resistance vs. Temperature

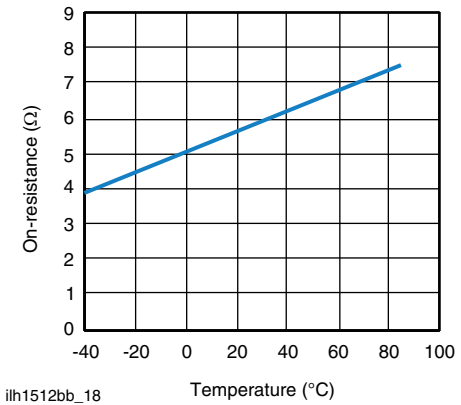
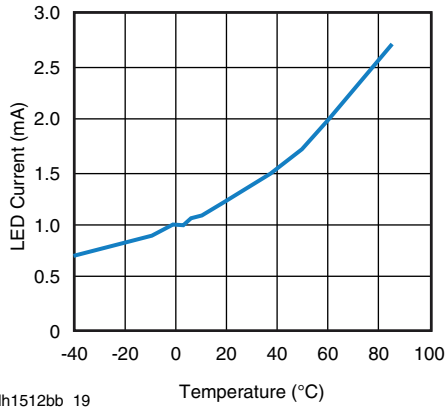
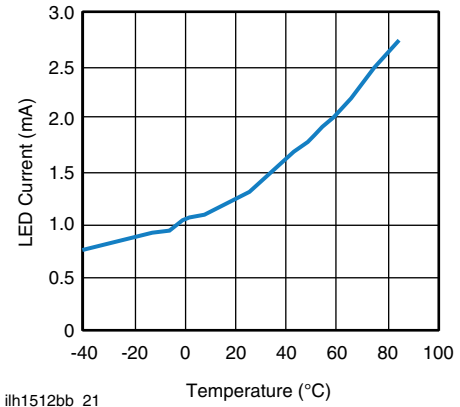


Fig. 18 - Form B Typical On-Resistance vs. Temperature



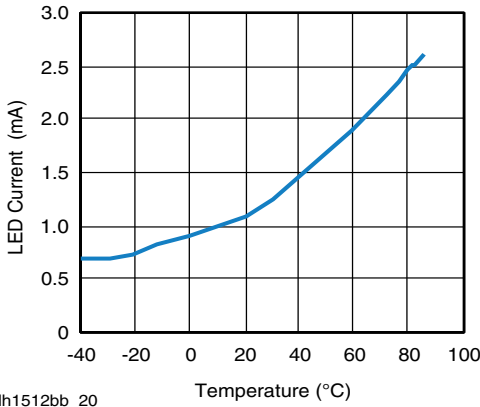
ilh1512bb_19

Fig. 19 - Form A Typical I_F for Switch Operation vs. Temperature



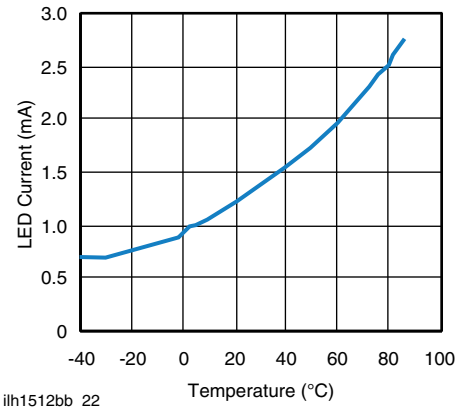
ilh1512bb_21

Fig. 21 - Form B Typical I_F for Switch Operation vs. Temperature



ilh1512bb_20

Fig. 20 - Form A Typical I_F for Switch Dropout vs. Temperature



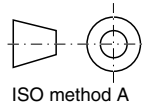
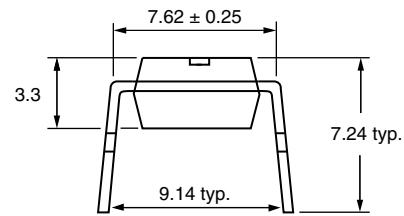
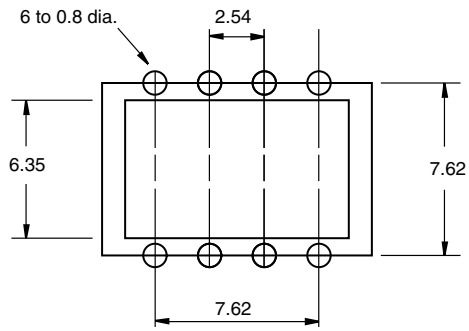
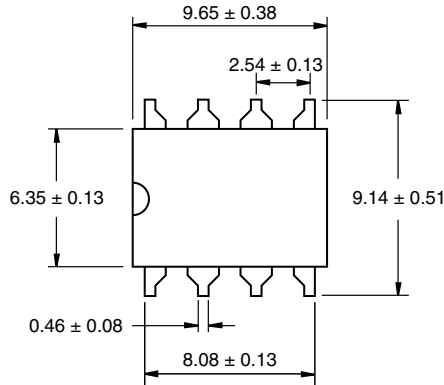
ilh1512bb_22

Fig. 22 - Form B Typical I_F for Switch Dropout vs. Temperature



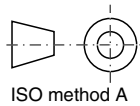
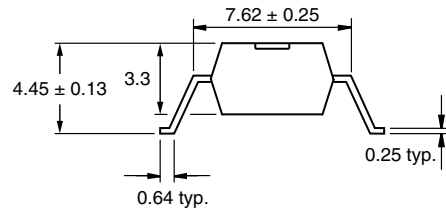
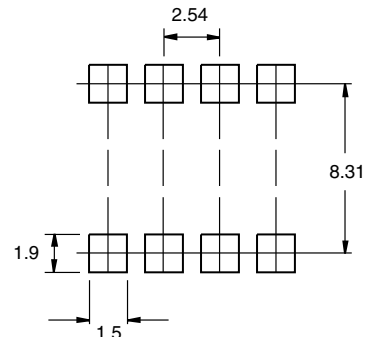
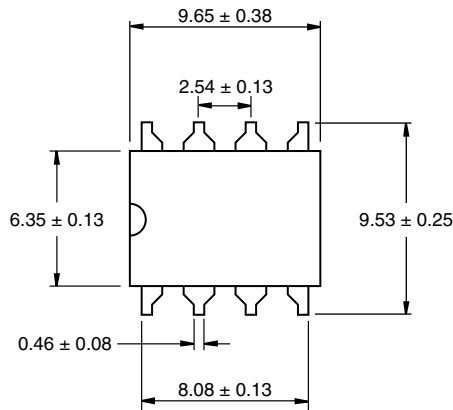
PACKAGE DIMENSIONS in millimeters

DIP



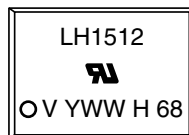
i178017

SMD



i178018

PACKAGE MARKING (example)

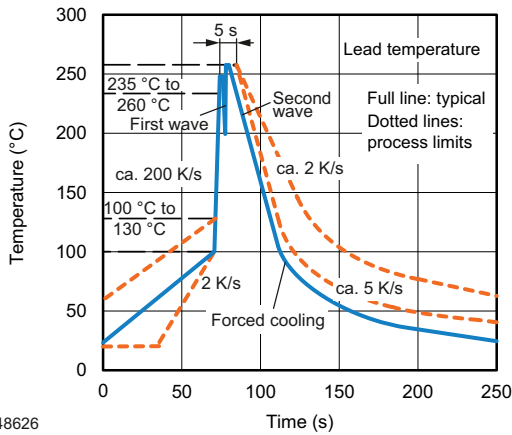


Note

- Tape and reel suffix (TR) is not part of the package marking

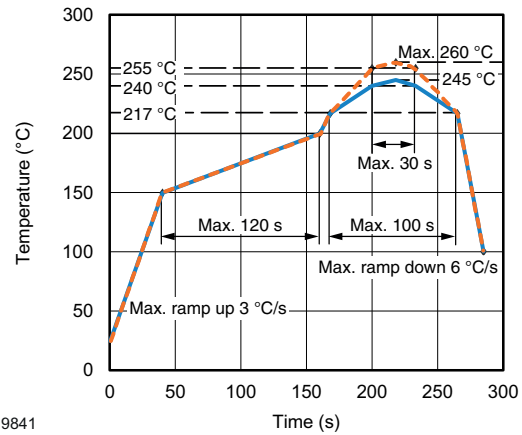


SOLDER PROFILES



948626

Fig. 23 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP Devices



19841

Fig. 24 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ °C}$, RH < 60 %

Moisture sensitivity level 1, according to J-STD-020



Footprint and Schematic Information for LH1512BAC, LH1512BACTR, LH1512BB

The footprint and schematic symbols for the following parts can be accessed using the associated links. They are available in Eagle, Altium, KiCad, OrCAD / Allegro, Pulsonix, and PADS.

Note that the 3D models for these parts can be found on the Vishay product page.

PART NUMBER	FOOTPRINT / SCHEMATIC
LH1512BAC	www.snapeda.com/parts/LH1512BAC/Vishay/view-part
LH1512BACTR	www.snapeda.com/parts/LH1512BACTR/Vishay/view-part
LH1512BB	www.snapeda.com/parts/LH1512BB/Vishay/view-part

For technical issues and product support, please contact optocoupleranswers@vishay.com.

DIP



SMD



i179034_2



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.